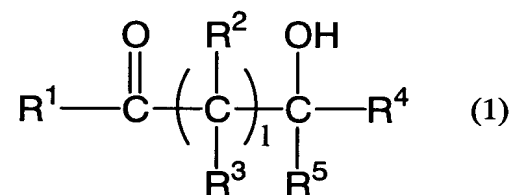


ABSTRACT OF THE DISCLOSURE

A photosensitive resin precursor composition exhibiting an excellent film thickness uniformity contains: a heat resistant resin precursor polymer; a radiation sensitive compound; and a solvent expressed by formula (1):



R^1 represents an alkyl group having a carbon number in the range of 1 to 3. R^2 , R^3 , R^4 , and R^5 each represent hydrogen or an alkyl group having a carbon number in the range of 1 to 3, and 1 represents an integer in the range of 0 to 3.